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Abstract—Present needs in efficiency and integration are driving research towards the miniaturization of power converters. Among the latest components to achieve the desired degree of integration are cored micro-inductors and they are still one of the hardest devices to optimize, due to the high number of freedom degrees in their fabrication. In this paper, a comprehensive design procedure for these micro-inductors is presented. The proposed method makes it possible to design the optimal device in a single iteration. It also allows the designer to easily ascertain the limits of the inductor in terms of handled current and losses and provides valuable physical insight on the output of the process.

Index Terms—PwrSoC, inductor-on-silicon, microinductor, integrated power, thin-film, race-track, planar BEOL, magnetics-on-silicon

I. INTRODUCTION

The optimization and miniaturization of power converters has been steadily ramping for many years. Although air-cored microinductors allow a reasonably high efficiency, a very large area is needed if the inductance exceeds a few nH, bringing down power density [1]. In the aim for the fully integrated Power-Supply-on-Chip (PwrSoC), micro-fabricated cored inductors have risen as one of the preferred choices [2]. Thanks to the new manufacturing technologies, that allow full control of every geometric parameter, micro-inductors make it possible to achieve inductance densities of up to more than a hundred nanohenries per square millimeter while maintaining a high efficiency [3], [4].

There are many structures available when designing a microinductor [5]. One of the most developed choices is the racetrack inductor, which consists of a copper conductor spiral, in two sections and surrounded by a magnetic core, as shown in Fig. 1. This geometry makes all the flux in the core travel along the hard anisotropy axis [6], reducing core losses [7], while easing the manufacture of the device [8].

Although the advantages of microinductors are clear, they come with the added difficulty of design complexity, derived from the high number of freedom degrees. In this regard, the design procedures are still not well developed [9], and so, new designs are mostly done by the comparison of thousands of possible parameter combinations, selected by multi-objective optimization methods, as in [8] and [10]. Whilst these methods allow the design of the optimum inductor, the amount of data needed makes it hard to integrate the process in the design of the whole power converter.

This paper presents the complete design procedure to find the optimum device in a single iteration, allowing an easy integration of inductor and converter optimization. It also gives the designer a broad insight on the limits of the technology, determined by the lowest achievable loss, the highest saturation current and the maximum allowed temperature increase.

The rest of the paper is organized as follows: Section II presents the equations needed to model the inductor; Section III states the problem and the need for the new design procedure; in Section IV, three new models for inductance calculation are proposed; Section V details the procedure to design the optimum device; Section VI validates the proposed procedure and, in Section VII, the main conclusions extracted from the process are presented.

II. MICRO-INDUCTOR MODEL

The physical model of the micro-inductor is depicted in Fig. 1. As shown in the picture, the racetrack inductor is a stretched circular spiral, where the magnetic core wraps the straight parts of the conductors. A detail of the cross-section of the conductor shows how the current is distributed in the conductor. To determine the inductor dimensions, it is very helpful to consider the device form factor \( D_{FF} \), a parameter that relates the length \( D_l \) and the width \( D_w \) of the inductor (2). If this parameter is close to one, the component is almost a round spiral inductor with no magnetic core. On the other hand, as the form factor increases, the inductor becomes more elongated, and therefore the contribution of the magnetic core and the straight section of the track becomes more significant.

\[
D_{FF} = \frac{D_l}{D_w} \quad (1)
\]

\[
D_{Arca} = \frac{D_l}{D_w} \quad (2)
\]
In this section, the equations that model the inductance and losses of this racetrack are presented.

### A. Inductance equations

Using the inductance models presented in [7], [10], [11], [12] and [13], the total inductance \( L \) of the device can be calculated as the sum of four terms (3): the inductance due to the presence of the core \( L_{\text{core}} \), calculated as the squared number of turns \( N \) divided by the reluctance of the core (4); the inductance of the spirals outside the core \( L_{\text{spiral}} \) (5); the self inductance of the straight wires under the core \( L_{w,\text{self}} \) (6); and the mutual inductances of the straight wires under the core \( L_{w,\text{mutual}} \) (7).

\[
L = L_{\text{core}} + L_{\text{spiral}} + L_{w,\text{self}} + L_{w,\text{mutual}} \quad (3)
\]

\[
L_{\text{core}} = \frac{\mu_0}{4} \frac{N^2}{N} \ln\left(\frac{2 \delta}{b} + 0.2 \left(\frac{\delta}{b}\right)^2\right) \quad (4)
\]

\[
L_{\text{spiral}} = \frac{\mu_0}{4} \frac{N^2}{N} \ln\left(\frac{2 \delta}{b} + 0.2 \left(\frac{\delta}{b}\right)^2\right) \quad (5)
\]

\[
L_{w,\text{self}} = \frac{\mu_0}{4} \frac{N^2}{N} \ln\left(\frac{2 \delta}{b} + 0.2 \left(\frac{\delta}{b}\right)^2\right) \quad (6)
\]

\[
L_{w,\text{mutual}} = \frac{\mu_0}{4} \frac{N^2}{N} \sum_{j=1}^{N-1} \sum_{k=j+1}^{N} \ln\left(\frac{1}{1 - \delta/b} \left(\frac{W_t + W_s}{W_t + W_s - W} \right) - 1\right) \left(\frac{1}{2} (W_t + W_s) \right) \quad (7)
\]

where

\[
L_{\text{mag}} = 2(C_t + W_t + \delta + \delta') \quad (8)
\]

\[
\delta = d_w - d_m \quad (9)
\]

\[
\delta' = d_w + d_m \quad (10)
\]

Fig. 2 shows the accumulated contribution of each inductance term relative to the total inductance, versus the device form factor. Two scenarios are shown: a thin core \((C_t = 1 \mu m)\) with a low number of turns \((N = 2)\); and a thick core \((C_t = 5 \mu m)\) with a relatively high number of turns \((N = 5)\).

For a fixed \(D_{FF}\), the thicker the core, the higher the impact of \(L_{\text{mag}}\), since the volume of magnetic material increases. The number of turns also has a major impact on \(L_{\text{core}}\), since it is squared in equation (4).

As can be seen, the impact of \(L_{\text{spiral}}\) reduces as \(D_{FF}\) increases, since the contribution of the spirals lowers with respect to that of the core and the straight wires. At low \(D_{FF}\) values, \(L_{\text{spiral}}\) becomes important and can even be the main inductance driver when the length of the spiral is greater than that of the straight wire tracks.

For every form factor, the mutual inductance represents a very small amount of the inductance. Once the device has an elongated shape, \(D_{FF} > 3\), which is usually the case [7], the impact of every inductance term remains almost constant. The analysis of this term distribution is key for the new inductance models that are going to be proposed in Section IV.

### B. Losses equations

Total loss, \(P\), can also be divided in four terms (11), as described in [7]: DC loss in the wire, \(P_{w,\text{DC}}\) (12); AC loss in the wire, \(P_{w,\text{AC}}\) (13); hysteresis loss in the core, \(P_{c,\text{hyst}}\) (14); and eddy current loss in the core, \(P_{c,\text{eddy}}\) (15).

\[
P = P_{w,\text{DC}} + P_{w,\text{AC}} + P_{c,\text{hyst}} + P_{c,\text{eddy}} \quad (11)
\]
where

\[ R_{DC} = \rho_{c} \frac{l_{c}}{W_{c} \cdot t_{c}} \]

\[ l_{km} = N \left(2 \cdot C_{t} + \pi \left(C_{t} + C_{u}\right)\right) \]

\[ \Delta B_{pp} = \frac{\mu_{0} \cdot \mu_{r} \cdot N \cdot l_{peak}}{t_{w} + D_{h}} \]

\[ C_{cal} = 2 \left(C_{t} + C_{u} + \Delta l_{m}\right) \]

\[ \delta_{k} = \sqrt{\frac{\rho_{c}}{\mu_{0} \cdot \mu_{r} \cdot \pi \cdot k \cdot f_{sw}}} \]

\[ H_{k} = \frac{N \cdot l_{peak}}{2 \cdot \left(t_{w} + D_{h}\right)} \]

where subscript \( k \) represents the \( k \)th harmonic of the wave.

In general, the inductor specifications from the designer’s point of view are inductance, \( L \), power loss, \( P \), operating frequency, \( f_{sw} \), rms and peak current through the device (\( I_{rms} \) and \( I_{peak} \) respectively) and maximum area that the device can occupy, \( D_{Area, max} \). To build the optimum device with these specifications and using the previously presented model, the designer needs to obtain the best combination of number of turns \( N \), core thickness \( C_t \), wire thickness \( W_c \), turn width \( W_{sw} \), and the remaining dimensions shown in Fig. 1. As shown in equations (3) to (26), inductance \( L \) and power loss \( P \) depend on many physical parameters, making the number of possible designs, for a given specification, very high. The most common approach to solve the issue is to find the optimum device using numerical methods, iterating through every possible parameter combination [9], [17].

**III. PROBLEM STATEMENT**

As can be seen, the main loss drivers are \( P_{e, DC} \) and \( P_{e, eddy} \) if this approximation does not suffice, the ones presented in [15] and [16], with increasing complexity, can be used. Fig. 3 shows the contribution of each loss term relative to the total loss versus the device form factor, for the same design parameters that are going to be used later in the design example and a fixed \( N \) of 2. For this comparison among the loss terms, \( D_{Area} \) and \( N \) are fixed and \( C_t \) takes the value needed to maintain a constant specified inductance (\( L_{s} \)) of 14.4 nH for every \( D_{FF} \).

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This optimization process yields the best design from the formulation of cost functions. However, it has some disadvantages, with loss of physical insight being one of them. Consequently, it becomes difficult to compare the achieved optimum design with other designs that are similar but not considered optimum, and which may present other advantages, difficult to formulate in a cost function, such as a decrease in the manufacturing complexity [18]. An added drawback of the numerical approach comes from the complexity of the equations and the amount of data generated for every parameter combination. Both aspects are time and resource consuming, making it hard to include the design of the microinductor in the optimization procedure of the whole power converter.

To overcome the problems of the amount of data generated (related to the number of variables) and the lack of physical insight (due to the numerical method), a new procedure for the design of racetrack microinductors is proposed in this paper.

To increase power density, these inductors can be built on top of the rest of the power converter (semiconductors, capacitors and control circuit) [19], [20]. Thus, the maximum allowable area is fixed for a given design. Additionally, as already studied in [10], the largest area always yields the lowest losses, so the selected device area, $D_{area}$, can be set to that maximum value, $D_{area,max}$.

To increase power density even further, other geometrical parameters (namely $W_s$, $C_{sw}$, $C_b$, $bi$, and $ti$) can be set to the minimum values allowed by the manufacturing technology, while wire thickness $W_t$ can be set to its maximum value to minimize DC resistance. Doing so, the design variables can be reduced to only three: number of turns $N$, core thickness $C_t$ and device form factor $D_{FF}$.

In (27-34), presented in Table I, the geometrical parameters required to compute the inductor model are expressed as a function of the three design variables $N$, $C_t$ and $D_{FF}$, and the fixed geometrical parameters $D_{area}$, $W_t$, $W_s$, $C_{sw}$, $C_b$, $bi$, and $ti$.

The minimum wire width ($W_{s,min}$) may be limited by the technology, but there is also a minimum width not to exceed the minimum specified temperature increase $\Delta T$ [35] [7]. And, for a given area, the shape of the device, defined by its form factor ($D_{FF}$), can take any value from 1 (same length as width) to the maximum $D_{area,max}$ (37), (an elongated device with $D_2$ as big as possible and the smallest $D_1$). This minimum device width ($D_{s,min}$), where only one turn of wire can be fitted while maintaining $C_t$ set to its maximum ($C_{t,max}$), can be calculated using (36). The definition of the design constants, along with the values used in the next examples, are presented in Table II.

In this paper the design problem is stated as follows: given the specifications in terms of inductance $L_m$, DC value and current ripple $I_{peak}$, and $I_{peak,min}$ respectively (only the 1st harmonic is considered), frequency of the current ripple $f_{sw}$, and maximum device area $D_{area}$, find the combination of number of turns $N$, core thickness $C_t$ and form factor $D_{FF}$ that yields the optimum design.

### Table I: Main Physical Relationships

<table>
<thead>
<tr>
<th>Design variables (unknowns)</th>
<th>$N$, $C_t$, $D_{FF}$</th>
</tr>
</thead>
<tbody>
<tr>
<td>$D_{area}$, $W_t$, $W_s$, $C_{sw}$, $C_b$, $bi$, and $ti$</td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Design constants</th>
<th>$D_{area}$, $W_t$, $W_s$, $C_{sw}$, $C_b$, $bi$, and $ti$</th>
</tr>
</thead>
<tbody>
<tr>
<td>$D_{s,min}$ = $D_{sw,min}$</td>
<td>(27)</td>
</tr>
<tr>
<td>$D_{s,max}$ = $\frac{D_{area}}{D_{FF}}$</td>
<td>(28)</td>
</tr>
<tr>
<td>$C_{sw} = \frac{D_{sw} - C_b}{2}$</td>
<td>(29)</td>
</tr>
<tr>
<td>$d_s = D_{sw} - 2C_{sw} - 2C_t$</td>
<td>(30)</td>
</tr>
<tr>
<td>$d_{sw} = C_s + 2C_{sw} + 2C_t$</td>
<td>(31)</td>
</tr>
<tr>
<td>$C_t = D_t - d_t - D_{sw} + 2C_{sw} + 2C_t$</td>
<td>(32)</td>
</tr>
<tr>
<td>$D_t = 2C_t + W_t + bi + bi$</td>
<td>(33)</td>
</tr>
<tr>
<td>$W_{s,min} = C_s - (N - 1)W_t - 2C_{sw} - 2C_t$</td>
<td>(34)</td>
</tr>
<tr>
<td>$W_{s,max} = \left( \frac{D_{area}}{W_t} \right)^2 (25.4 \times 10^{-5})^2$</td>
<td>(35)</td>
</tr>
<tr>
<td>$D_{area,min} = C_s + 4C_{sw,max} + 4C_t + 2W_{s,min}$</td>
<td>(36)</td>
</tr>
<tr>
<td>$D_{FF,max} = \frac{D_{area,min}}{D_{s,min}}$</td>
<td>(37)</td>
</tr>
</tbody>
</table>

### Table II: Design Example Parameters

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Description</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>$W_s$</td>
<td>Wire-to-wire spacing</td>
<td>15 μm</td>
</tr>
<tr>
<td>$C_{sw}$</td>
<td>Core-to-wire spacing</td>
<td>15 μm</td>
</tr>
<tr>
<td>$C_s$</td>
<td>Core-to-core spacing</td>
<td>250 μm</td>
</tr>
<tr>
<td>$W_t$</td>
<td>Wire thickness</td>
<td>15 μm</td>
</tr>
<tr>
<td>$C_t$</td>
<td>Core thickness</td>
<td>0.25 - 5 μm</td>
</tr>
<tr>
<td>$bi$</td>
<td>Bottom insulator thickness</td>
<td>10 μm</td>
</tr>
<tr>
<td>$ti$</td>
<td>Top insulator thickness</td>
<td>65 μm</td>
</tr>
<tr>
<td>$N_{core}$</td>
<td>Core material permittivity</td>
<td>9.45 \times 10^{12} F/m</td>
</tr>
<tr>
<td>$\mu_s$</td>
<td>Saturation flux density</td>
<td>1.4 T</td>
</tr>
<tr>
<td>$\mu_{rel}$</td>
<td>Relative permeability of the core</td>
<td>4 \times 10^{-7}</td>
</tr>
<tr>
<td>$\mu_t$</td>
<td>Relative permeability of the copper</td>
<td>280</td>
</tr>
<tr>
<td>$\beta$</td>
<td>Steinmetz K factor</td>
<td>300</td>
</tr>
<tr>
<td>$\beta_{rel}$</td>
<td>Steinmetz &amp; beta factor</td>
<td>1.73</td>
</tr>
<tr>
<td>$\epsilon_r$</td>
<td>Permittivity of the insulator</td>
<td>4.5</td>
</tr>
<tr>
<td>$\rho_{rel}$</td>
<td>Copper resistivity</td>
<td>1.72 \times 10^{-8} Ωm</td>
</tr>
<tr>
<td>$\rho_{core}$</td>
<td>Relative permeability of the core</td>
<td>1</td>
</tr>
<tr>
<td>$\Delta T$</td>
<td>Allowable inductor temperature rise</td>
<td>80 K</td>
</tr>
<tr>
<td>$k_{b}$</td>
<td>k factor for Minimum Wire Width</td>
<td>0.648</td>
</tr>
<tr>
<td>$k_{f}$</td>
<td>k factor for Minimum Wire Width</td>
<td>0.44</td>
</tr>
<tr>
<td>$I_{DC}$</td>
<td>DC current</td>
<td>1.29 A</td>
</tr>
<tr>
<td>$f_{peak}$</td>
<td>Frequency</td>
<td>150 MHz</td>
</tr>
<tr>
<td>$I_{peak,min}$</td>
<td>Peak value of current’s first harmonic</td>
<td>0.1 A</td>
</tr>
<tr>
<td>$D_{area}$</td>
<td>Device Area</td>
<td>0.813 mm²</td>
</tr>
<tr>
<td>$L_m$</td>
<td>Specified inductance</td>
<td>11.4 mH</td>
</tr>
</tbody>
</table>
IV. PROPOSED MODELS

The inductor model described in sections II and III contains nonlinear relationships between the design variables \((N, C_l,\) and \(D_{FP}\)) that are difficult to manage in terms of having a straightforward approach to analysing the influence of every design variable.

In this section, three simplified models, with linear relationships between the design variables, are proposed to establish the design procedure.

A. Model 1

In (3), both \(L_{w\text{,self}}\) and \(L_{w\text{,mutual}}\) contain a natural logarithm where \(N\) and \(C_l\) are present in both numerator and denominator, making them transcendental functions, which can not be easily solved. Since \(L_{w\text{,self}}\) and \(L_{w\text{,mutual}}\) are usually the less significant inductance terms \([7]\), in this first approach they are omitted, so the inductance can be calculated by means of (38).

\[
L_1 = L_{\text{core}} + L_{\text{spiral}} \tag{38}
\]

Because of the simplicity of this model, it is possible to calculate the number of turns as a function of \(D_{FP}\) and \(C_l\) to achieve a specified inductance \(L_1\).

\[
N_{l1}(C_l, D_{FP}) = \sqrt{\frac{L_1}{\mu_0 \left[ \ln \left( \frac{D_{FP}}{r_w} \right) + 0.2 \left( \frac{D_{FP}}{r_w} \right)^2 \right] + 2 \mu_0 \mu_s C_l C_m}} \tag{39}
\]

\(L_1\) equals \(L_{\text{core}} + L_{\text{spiral}}\) so its accuracy is lower for low values of \(N\) and high values of \(D_{FP}\). The lowest accuracy of \(L_1\), for the example shown in Fig. 2 \((N = 2, C_l = 1\mho)\) is only 64%.

This model can serve as a good initial approximation to calculate the number of turns, but may yield a considerable error depending on the relative impact of \(L_{w\text{,self}}\) and \(L_{w\text{,mutual}}\). This results in a predicted number of turns \(N_1\), equal to or higher than the required \(N\), considering the complete model.

B. Model 2

The model can be improved in a second step by also including \(L_{w\text{,self}}\). However, this expression includes a natural logarithm containing \(C_l\) and \(N\). To overcome this inconvenience, \(L_{w\text{,self}}\) can now be made dependent only on \(C_l\) by substituting \(N_1\) (39) for \(N\) in (6). This way, a better approximation for inductance can be derived as:

\[
L_2 = L_{\text{core}} + L_{\text{spiral}} + L_{w\text{,self}} \tag{40}
\]

\(L_2\) is very close to \(L_{\text{core}} + L_{\text{spiral}} + L_{w\text{,self}}\). As shown in Fig. 2, that sum of inductances makes up for up to 95% of total inductance if \(N \geq C_l\) are at their highest, even for the highest \(D_{FP}\). Also notice that since \(N_1 \geq N\), \(L_{w\text{,self}}\) is always going to be equal to or higher than \(L_{w\text{,self}}\), so the absence of \(L_{w\text{,self}}\) in the model is partially compensated.

With this model, \(N\) can be more accurately calculated to achieve the specified inductance \(L_2\) by means of (41).

\[
N_2(C_l, D_{FP}) = \frac{-b_N + \sqrt{b_N^2 - 4a_N c_N}}{2a_N} \tag{41}
\]

where:

\[
a_N = \frac{\mu_0 N^2}{4} \left[ \ln \left( \frac{2.46}{\pi D_{FP}} \right) + 0.2 \left( \frac{D_{FP}}{r_w} \right)^2 \right] + 2 \mu_0 \mu_s C_l C_m \tag{42}
\]

\[
b_N = \frac{C_l \mu_0}{\pi} \ln \left( \frac{2C_l}{D_{FP} - 2C_l + 2C_m (N - 1)} \right) \frac{1}{2} \tag{43}
\]

\[
c_N = -L_s \tag{44}
\]

This model allows the calculation of the required number of turns \(N\), for a particular core thickness \(C_l\). However, it does not allow calculation of the core thickness \(C_l\) for a given number of turns \(N\) and form factor \(D_{FP}\).

C. Model 3

In this approach, some physical approximations can be made to reduce the complexity of the equations by getting rid of some terms that may be neglected:

- To approximate \(L_{\text{core}}\): if the core thickness is much lower than the core length \((C_l << C_h)\), (32) can be approximated by (45) and the inductance due to the core can then be approximated as (46).

\[
C_l(D_{FP}) \approx C_3(D_{FP}) = D_l - D_a + 2C_m \tag{45}
\]

\[
L_{\text{core,3}} = \frac{2N^2 \mu_0 \mu_s C_l}{\pi} \left( D_l - D_a + 2C_m \right) \tag{46}
\]

- To approximate \(L_{\text{spiral}}\): if the core thickness is much lower than the outer diameter of the spiral \((C_l << d_m)\), and also lower than the internal diameter of the spiral \((C_l << d_m)\), (30), (31), (9) and (10) can be approximated by (47), (48), (49) and (50) respectively. Thus, the inductance of the spiral can be calculated by means of (51).

\[
d_{sl} \approx d_m = D_m - 2C_m \tag{47}
\]

\[
d_{sl} \approx d_m = C_4 + 2C_m \tag{48}
\]

\[
\delta \approx \delta_s = D_m - 4C_m - C_l \tag{49}
\]

\[
\delta' \approx \delta' = D_m + C_l \tag{50}
\]

\[
L_{\text{spiral,3}} \approx \frac{\mu_0 N^2 N_3}{4} \left[ \ln \left( \frac{2.46}{\pi N_3} \right) + 0.2 \left( \frac{N_3}{r_w} \right)^2 \right] \tag{51}
\]

- To approximate \(L_{w\text{,self}}\): if \(C_l << 0.5 \cdot N \cdot W_w\) and \(C_l << C_s\), (34) can be approximated by (52), and the self inductance of the straight wires can be calculated using (53).

\[
W_w \approx W_{w1} = \frac{C_m - (N - 1)W_2 - 2C_m}{N} \tag{52}
\]
\[ L_{\text{core},1}\,\text{F},1 = \frac{N}{2} \left( 2C_{\text{AC}} + D_t - D_a \right) \]

\[ \frac{L}{N} = \left[ \frac{2}{W_1 + \frac{2}{N}C_{\text{DC}}} \right] \frac{1}{2} + 1 \]

- To approximate \( L_{\text{mutual},1} \): taking the previous assumptions, \( W_2 \) can be substituted by \( W_{\text{DC},1} \) and \( C_1 \) by \( C_{\text{AC}} \) in (7). By doing so, the mutual inductance of the straight wires can be calculated using (54).

\[ L_{\text{mutual},1} = \frac{\ln(\text{FF})}{N} \sum_{i=1}^{N-1} \sum_{j=1}^{N} \frac{(L_{\text{DC},1} + W_{\text{AC},1})}{(L_{\text{DC},1} + W_{\text{AC},1})^2} + 1 \]

Taking into account all the previous approximations, a new model to calculate the inductance \( L_3 \) is introduced (55).

\[ L_3 = L_{\text{core},1} + L_{\text{spiral},1} + L_{\text{mutual},1} \]

Since \( C_1 \) is not inside a natural logarithm anymore, it can be found, to achieve a specified inductance \( L_3 \), by means of (56).

\[ C_{1,N}(N, D_{FP}) = \frac{C_{\text{AC}} + (2C_{\text{DC}} + D_t - D_a) \times (C_{\text{DC}} + W_1 + t + t_i)}{N} \]

\[ (L_3 - L_{\text{core},1} - L_{\text{spiral},1} - L_{\text{mutual},1}) \]

This error when calculating inductance implies the designed device is not the one that exactly meets specifications, but a close one (in terms of the selection of \( D_{FP} \), \( N \) and \( C_1 \)). As stated before, for every \( D_{FP} \), there would be an overestimation of \( N \) and/or \( C_1 \) when using any of the models. The overestimation of \( N \) means the wire will be longer and thinner than needed, increasing wire losses (\( P_{\text{self}}, \text{AC} \) and \( P_{\text{self}, \text{DC}} \)) and the overestimation of \( C_1 \) means there will be more core material than is really needed, increasing core losses (\( P_{\text{l}, \text{self}} \) and \( P_{\text{l}, \text{mutual}} \)).

To analyse the impact of the models on the losses, a different test has been conducted. For instance, for Model 1 and a given \( D_{FP} \), the number of turns \( N_1 \) was calculated by means of (39) and the core thickness was adjusted by an iterative approach to determine the core thickness \( C_{1,1} \) required to obtained \( L_3 = 14\, \text{mH} \). The resulting number of turns \( N_1 \) and core thickness \( C_{1,1} \) have been used to calculate the total loss using the complete model \( P(N_1, C_{1,1}) \). A similar procedure was used to calculate the number of turns and core thickness for models 2 and 3 and compute their total loss.

The results are depicted in Fig. 5, which represents the comparison of the loss achieved with the different models compared to the complete model. As explained before, the FEA results (shown as diamonds in the figure) match with high accuracy the losses for \( D_{FP} \) higher than 2.2, with a difference within \( \pm 2.5\% \). However, this accuracy depends on the design of the component itself due to the relative contribution of the eddy loss compared to other losses, as depicted in Fig. 3. In this particular example, the maximum deviation of the loss is 30\% for the worst case. In that case the core is very thin and the edge effect plays an important role. Moreover, the number of turns is low and eddy losses are dominant. In other designs with higher number of turns, the losses due to the wire could make the relative contribution of the eddy loss less important, and thus the accuracy of the model would increase.

As can be seen in Fig. 5, the overestimation of \( N \) and/or...
Fig. 5. Loss predicted by every model

$C_t$ when using Model 1 results in a device with losses $P(N_1, C_t)$ much higher than $P(N, C_t)$ (up to 28% increase for this particular example) which, again, makes it unsuited for the design. $C_t(N_1)$ has been calculated iteratively using expression (38). On the other hand, the increase in losses due to the use of Model 2, needed to calculate $N$, is considered acceptable in exchange for the reduction in complexity (less than 6% increase for this particular example). Model 3, which is used to finely adjust the value of $C_t$ to meet the specifications, presents a very small error, as it does when calculating inductance.

The small difference between the losses predicted by Model 3, and the ones calculated using the model without any approximation, ensures the designed device is very close to the optimum one.

V. DESIGN PROCEDURE

In this section, a new design procedure, using the models presented in the section IV, is detailed. The flowchart for the proposed procedure is shown in Fig. 6 and, to illustrate the process, an example of the output of every step, using the values provided in Table II, is shown in figures 7 to 10.

A. Step 1: Check feasibility of the solution

The maximum possible inductance is achieved by using the maximum amount of core material ($C_t$) while fitting the maximum number of turns ($N$).

The upper limit of the number of turns ($N_{ul}$) that can fit in the device, depends on the minimum wire width ($W_{s,min}$) and the maximum core thickness $C_{t,max}$ (57). Notice that, since the number of turns has to be discrete, $N_{ul}$ is rounded down.

$$N_{ul}(D_{FF}) = \text{floor} \left( \frac{C_{w} - C_{ts} - 2C_{t,max} + W_{s}}{W_{s} + W_{s,min}} \right) \quad (57)$$

$N_{ul}$ is different for every device form factor. For a given area, and the values provided in Table II, the upper limit for the number of turns for any possible form factor is shown in Fig. 7.

Once the limit for the number of turns is known, $N$ can be substituted by $N_{ul}$ in equations (3) to (7) and the maximum achievable inductance ($L_{max}$) can be calculated as:

$$L_{max} = L_j N = N_{ul} C_t = C_{t,max} \quad (58)$$

For the values provided in Table II, the maximum achievable inductance for any possible form factor is shown in Fig. 8. The sawtooth shape of the curve derives from rounding down of the number of turns shown in Fig. 7. Since $N$ has a major impact on inductance value (equations (3) - (10)), the $D_{FF}$ values where there is a change on the maximum number of turns show a very pronounced difference in achievable inductance. This highlights the big impact that very small differences in geometry ($D_{FF}$) can have when designing a microinductor.

If the specified inductance value (purple line in Fig. 8) is lower than the maximum inductance (blue line), the value is achievable for the valid form factors ($D_{FF}$). Otherwise, the design should be stopped at this point and the specifications should be revised.
B. Step 2: Valid number of turns

Next, the values that the number of turns can take to provide the specified inductance are found. In this step, Models 2 and 3 are used.

To obtain the minimum needed number of turns to achieve a specified inductance \(N_{\text{min}}\), \(C_t\) can be substituted by its maximum value, \(C_t;\text{max}\) in (41):

\[
N_{\text{min}} = \text{ceil}(\frac{N^2}{2C_t}) = C_t;\text{max}\quad(59)
\]

For the maximum number of turns \(N_{\text{max}}\), 3 conditions have to be met.
- The specified inductance is achieved.
- The maximum number of turns to achieve a given inductance can be obtained substituting \(C_t\) by \(C_t;\text{min}\) in (41):
  \[
  N_{\text{max}};L = \frac{N^2}{2C_t} = C_t;\text{min}\quad(60)
  \]
- The maximum temperature increase is not reached.
  To ensure the temperature stays within its allowed range, \(W_w\) has to be higher than \(W_w;\text{min}\), which translates into:
  \[
  N_{\text{max}};T = \frac{C_w + W_s + 2C_t}{W_w;\text{min} + W_s}\quad(61)
  \]
- The device will not saturate at maximum current.
  The maximum current to avoid saturating the core can be calculated as:
  \[
  I_{\text{sat}} = B_{\text{sat}} \frac{2(C_w + 2C_t + W_s + b_i + t_i)}{\mu_0 i_{pp} N}\quad(62)
  \]

The local minimums for this cost function are defined by (68) and (69):
\[
\frac{\partial P_3(N, D_{FF})}{\partial D_{FF}} = 0\quad(68)
\]
\[
\frac{\partial^2 P_3(N, D_{FF})}{\partial D_{FF}^2} > 0\quad(69)
\]
Since the \(D_{FF}\) range for every number of turns is limited, being a local minimum does not suffice to be an absolute minimum and the value at the boundaries (minimum and maximum number of turns that ensures the three conditions are met is calculated as the lowest of the three maximum limits:

\[
N_{\text{max}} = \text{floor}(\min(N_{\text{max}}, N_{\text{max}}, N_{\text{max}}))\quad(65)
\]

Once the maximum and minimum values are known, the selected \(N\) will always be between them:

\[
N_{\text{min}} \leq N \leq N_{\text{max}}\quad(66)
\]

For the values provided in Table II, the valid numbers of turns are shown in Fig. 9. Any value between or on the yellow and blue lines, is a valid number of turns for a given form factor.

C. Step 3: Optimum device

Once the valid number of turns for every \(D_{FF}\) is known, the optimum device can be found. This procedure can be adapted to the use of any cost function, as long as it can be expressed as functions of \(D_{FF}\), \(N\) and \(C_t\). In the present example, the cost functions are total loss and device volume and the optimum device is defined as that with the minimum loss.

Total loss can be approximated using (67) by substituting \(C_t\) by \(C_t;\text{min}\) in (11) and thus making it dependant only on \(N\) and \(D_{FF}\):

\[
P_3(N, D_{FF}) = P_3'(C_t;\text{min}, N)\quad(67)
\]

The local minimums for this cost function are defined by (68) and (69):

\[
\frac{\partial P_3(N, D_{FF})}{\partial D_{FF}} = 0\quad(68)
\]
\[
\frac{\partial^2 P_3(N, D_{FF})}{\partial D_{FF}^2} > 0\quad(69)
\]

The maximum number of turns that ensures the three conditions are met is calculated as the lowest of the three maximum limits:

\[
N_{\text{max}} = \text{floor}(\min(N_{\text{max}}, N_{\text{max}}, N_{\text{max}}))\quad(65)
\]

Once the maximum and minimum values are known, the selected \(N\) will always be between them:

\[
N_{\text{min}} \leq N \leq N_{\text{max}}\quad(66)
\]

For the values provided in Table II, the valid numbers of turns are shown in Fig. 9. Any value between or on the yellow and blue lines, is a valid number of turns for a given form factor.
maximum \( D_{FF} \) values for every number of turns) has also to be checked. Thus, the combination of \( N \) and \( D_{FF} \) that yields the optimum device is defined as that which provides the total minimum power loss:

\[
\{N_{opt}, D_{FFopt}\} = \{N, D_{FF}\} \mid P_3 = \text{min}(P_3) \tag{70}
\]

For the values provided in Table II and the valid numbers of turns previously calculated (Fig. 9), the resulting total losses are shown in Fig. 10. The optimum device, resulting from the previous calculation, is highlighted with a yellow diamond.

Once the optimum \( N \) and \( D_{FF} \) are known, the only remaining design variable, \( C_t \), can be calculated using (71).

\[
C_{t, opt} = C_{3,3}(N_{opt}, D_{FFopt}) \tag{71}
\]

After this last step, every physical parameter is known:

- \( W_s \), \( C_{ks} \), \( C_s \), \( b_i \), and \( t_i \) are set to their minimum values to increase power density.
- \( W_s \) and \( D_{area} \) are set to their maximum to reduce losses.
- \( D_{FF} \), \( N \) and \( C_t \) have their optimum values, given by the presented design procedure.

The calculation of the remaining parameters shown in Fig. 1 is straightforward using equations (27)-(34) and so, every physical dimension is known and the optimum device can be built.

Even though the design could stop at this point, the previous figures shown in this section highlight one of the advantages of the presented procedure over the traditional numerical approximation: the physical insight on the design. The two most important conclusions extracted from those figures are:

- As can be seen in figures 7 to 10, there are very big differences in the designed device when there is a change in the number of turns (shown as steps or discontinuities in the graphs). So, even if the area and shape of the inductor were in principle to be imposed by the rest of the circuit, slight modifications in that area could yield big improvements for the inductor by enabling a wider range of number of turns.
- As shown in Fig. 10, even though there is only one optimum device, there can be designs that, with only a slight decrease in performance, could be more interesting from the manufacturing point of view, for example by reducing the number of turns (and making them wider and more immune to process variability) or reducing core thickness (\( C_t \)) (reducing processing time and cost).

VI. VALIDATION OF THE DESIGN PROCEDURE

The proposed procedure has been compared to a numerical approach based on the calculation of all possible inductor designs taking into account all the combinations of the physical parameters (summarized in Table II). The resulting 300,000 designs are shown in Fig. 11 as blue dots. Superimposed on them there are two diamonds: the optimum device given by the numerical approximation, in purple, and the one given by the proposed procedure, in yellow (corresponding to the one shown in Fig. 10). The proposed procedure achieves a near optimal design while dramatically reducing the amount of processed data.

The main parameters of the output designs obtained by the numerical approximation and the proposed procedure are shown in Table III. The detailed comparison of both designs is shown in Fig. 12 (inductance) and Fig. 13 (losses). As shown, the designs obtained by calculating thousand of possible parameter combinations using the complete inductance and loss models and the one resulting from a single iteration of the proposed design procedure are almost the same. Both have the same \( N \), there is less than a 1% deviation in \( C_t \) and \( D_{FF} \) and in inductance and loss.

As stated before, the difference in the calculations is due to a small overestimation of \( D_{FF} \) or \( C_t \), which results in an excess of core material. This excess yields an inductance slightly higher than specified (Fig. 12) as well as slightly higher losses.
Since this error is always an overestimation, it can be partially compensated by reducing the value of $C_t$ or $D_{FF}$ given by the proposed model.

<table>
<thead>
<tr>
<th>TABLE III</th>
<th>OPTIMUM DEVICE PARAMETERS</th>
</tr>
</thead>
<tbody>
<tr>
<td>$N$</td>
<td>$C_t$ ($\mu$m)</td>
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<td>Numerical approach</td>
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<tr>
<td>Proposed procedure</td>
<td>2</td>
</tr>
<tr>
<td>Difference</td>
<td>-</td>
</tr>
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</table>

Finally, to experimentally verify the accuracy of the analytical equations and the proposed models, a manufactured device has been modeled using Ansys Maxwell 3D as well as measured in the laboratory. Due to fabrication purposes, instead of manufacturing the optimized device in terms of losses (Table III), the choice was to use less core material with a reduced form factor. This device corresponds to the one with the lowest loss for $N = 3$ (Fig. 10), which has $C_t = 1.647\, \mu$m and $D_{FF} = 1.53$. The fabricated microinductor is a coupled inductor with an additional winding, as shown in Fig. 14. This additional winding is not considered in our models. However, it has been used for the calculation of core losses in large-signal tests [21]. Voltage and current were measured using voltage probes and a sense capacitor, with the phase correction method described in [22], producing excitation signals in accordance to the specified DC and AC current through the device [23], shown in Table II. The used equipment are: three Tektronix TAP1500 voltage probes (1.5GHz), a Tektronix MD03104 mixed domain oscilloscope (5GS/s, 1GHz) and an Applied Research 25A250A power amplifier.

These measurements were used to calculate core losses. To separate between hysteresis and eddy current losses in the core, large signal measurements were done in a frequency range. Steinmetz parameters can be obtained from a low frequency measurement, where hysteresis losses are dominant.

The permeability value ($\mu_r$) was initially measured on blanket magnetic material and was further adjusted to be consistent with inductance measurements of fabricated devices. The accuracy of the presented method is related to the material parameters in Table II, since they are essential to calculate the inductance and the losses.

The experimental measurements (with open secondary winding) and the finite element analysis (FEA) results are compared with our best design for $N = 3$ in Table IV. As can be seen, the values given by the analytical equations and the proposed model are in very good agreement with both measurements and FEA results, with the only discrepancy of eddy loss ($P_{\text{eddy}}$), which may be due to the unconsidered open winding. These results validate our proposal.

| Fig. 14. Top view of the fabricated microinductor | Fig. 12. Optimum devices inductance comparison | Fig. 13. Optimum devices losses comparison |

VII. CONCLUSION

This paper presents a complete procedure for the design of a racetrack microinductor. In contrast to previously presented numerical approaches, it avoids the need to calculate for every parameter combination in order to design the optimum device. Additionally, the proposed process ensures critical design

"..."
requirements are met, the inductance value is achievable and the temperature rise will be kept below the specified value.

The new procedure is based on three proposed models for inductance calculation, which reduce the complexity of the equations and allows a simpler relationship between the design variables. This translates in a big reduction in the computation time of the design, and facilitates the integration of the inductor design in the design of a power converter.

An example of an inductor designed using the proposed method, has been compared to the optimum design calculated by a manufactured device has been measured. The theoretical reduction in magnetic material, or slightly changing the shape of the device for a large increase in performance.

An example of an inductor designed using the proposed methods, has been compared to the optimum design calculated by a conventional approach, based on the analysis of all possible physical combinations. Discrepancies between the two models are less than 1% in inductance and losses, confirming the accuracy of the proposed straightforward procedure.

Finally, to validate the analytical equations and the models, a manufactured device has been measured. The theoretical results match both measurements and finite element simulations, which ensures the suitability of the proposal.

**REFERENCES**


**TABLE IV**

<table>
<thead>
<tr>
<th></th>
<th>( L ) (nH)</th>
<th>( P_{c,DC+AC} ) (mW)</th>
<th>( P_{c,eddy} ) (mW)</th>
<th>( P_{c,hen} ) (mW)</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Best design</strong></td>
<td>14.5</td>
<td>1.8</td>
<td>1.6</td>
<td>1.6</td>
</tr>
<tr>
<td><strong>Mean</strong></td>
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<td>1.7</td>
<td>1.8</td>
<td>4.2</td>
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<tr>
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<td>14.5</td>
<td>12.6</td>
<td>1.2</td>
<td>1.2</td>
</tr>
</tbody>
</table>